# POEA1FB

# Power over ethernet (PoE)/PD flyback transformer



#### **Product features**

- · Flyback topology
- · IEEE 802.3xx
- Up to 300 kHz switching frequency
- · Input range from 33 V to 72 V
- EP10 SMT package (15.2 mm x 12.5 mm x 11.6 mm)
- 1500 Vac isolation between primary and secondary
- · Three power levels: 3, 7 and 10 watts
- · Low leakage inductance
- · Ferrite core material
- · Moisture sensitivity level (MSL): 1

#### **Applications**

- · Lighting
- · Industrial automation
- · Security systems
- · VoIP phone systems
- · Network and Bluetooth access points
- · Network routers, repeaters
- · Uninterruptible power supplies (UPS)
- · Retail point-of-information (POI) systems
- · Vending and gaming machines
- Remote cameras

# Environmental compliance and general specifications

- Storage temperature (component):
   -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)









#### **Product specifications**

Turns ratio
Schematic 1: Pri : Sec 1 :
Sec 2 : Aux
Schematic 2: Pri : Sec
1 : Aux

Part number⁴	Output power (W)	OCL <sup>1</sup> (µH) ±10%	SCL² (µH) maximum	I <sub>sat</sub> <sup>3</sup> (A)	Schematic 3: Pri : Sec 1 : Aux Schematic 4: Pri : Sec 1 ±3%	Output	DCR (mΩ) maximum @ +25 °C (Pri)	DCR (mΩ) maximum @ +25 °C (Sec 1)	DCR (mΩ) maximum @ +25 °C (Sec 2)	DCR (mΩ) maximum @ +25 °C (Aux)	Schematic
POEA1FB1V3W2X5	3	155 ± 15%	2.8	0.80	1:0.146:0.146:0.313	(2) x 5.0 V	350	50	150	320	1
POEA1FB1V7W1X5	7	253	7.5	0.45	1:0.125:0.208	(1) x 5.0 V @ 1.4 A	420	16	-	115	2
POEA1FB1V7W1X12	7	155	3.25	0.75	1 :0.667: 0.667	(1) x 12.0 V @ 0.6 A	414	343	-	822	3
POEA1FB1V10W1X12	10	60	1.7	1.20	1:1	(1) x 12.0 V @ 0.83 A	130	170	-	-	4

- 1. Open circuit inductance (OCL) is for the primary, test parameters: 100 kHz, 0.1 V<sub>mot</sub>, 0.0 Adc, +25 °C
- 2. Short circuit inductance (SCL) is for the primary with the other windings shorted, test parameters: 100 kHz, 0.1 V<sub>met</sub>

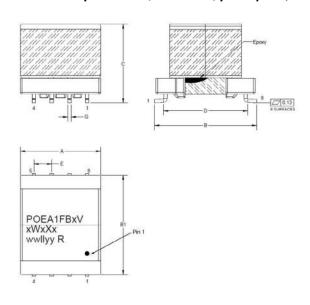
0.0 Adc, +25 °C

- 3.  $I_{\mbox{\tiny sat}}$  is for the primary, peak current for less than or equal to 10% rolloff @ +25 °C
- 4. Part Number Definition: POEA1FBxVxWxXx

POEA1FB=Product code and size

xVxW, xV=Version indicator, xW= output power, xXx=number of outputs and output voltage

#### Mechanical parameters, schematic, pad layout (mm)

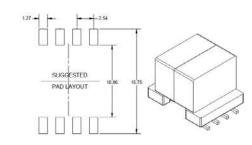


Dimension	Value
A	12.5 maximum
В	15.24 maximum
B1	14.2 ± 0.5
С	11.6 maximum
D	12.04 typical
E	2.54 ± 0.3
G	0.5 ± 0.1

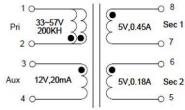
Part marking: Dot= Pin 1, POEA1FB = Product code and size, xV=Version indicator, xW= Output power, xXx=number of outputs and output voltage. wwllyy R= Lot code All pin length doesn't include tin icicles All soldering surfaces to be coplanar within 0.13 millimeters Tolerances are ±0.25 millimeters unless stated otherwise Pad layout tolerances are ±0.1 millimeters unless stated otherwise

Traces or vias underneath the transformer is not recommended

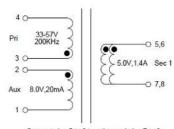
#### Recommended PCB Layout



#### Schematic 1

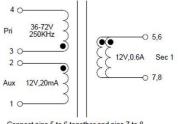


#### Schematic 2



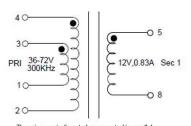
Connect pins 5 to 6 together and pins 7 to 8 together on the PCB board

#### Schematic 3



### Connect pins 5 to 6 together and pins 7 to 8 together on the PCB board

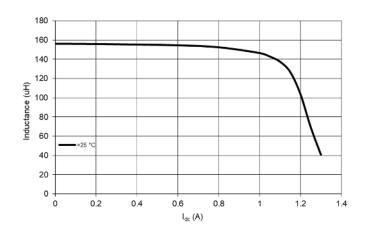
#### Schematic 4



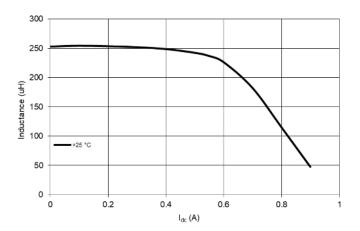
The primary windings to be connected in parallel on the PC board. Connect pins 1 to 2 and pins 3 to 4.

#### OCL (inductance) vs current characteristics

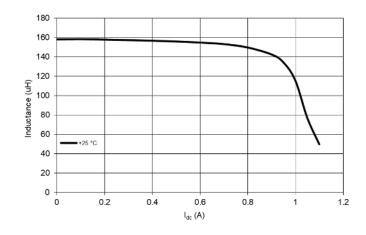
#### POEA1FB1V3W2X5



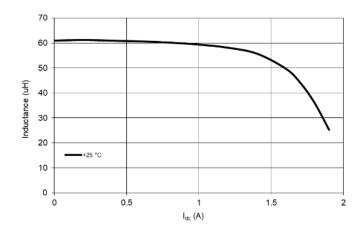
#### POEA1FB1V7W1X5



#### POEA1FB1V7W1X12

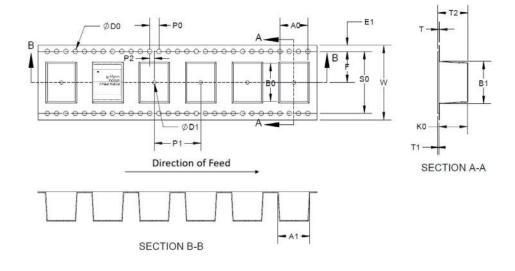


#### POEA1FB1V10W1X12



#### Packaging information (mm)

Supplied in tape and reel packaging, 13" diameter reel (EIA-481 compliant) 200 parts per reel



Value
32
14.2
1.75
4
20
2
1.5
2
12
9.6
16.4
14.8
12
0.5
0.1
12.7
28.4

### Power over ethernet (PoE)/PD flyback transformer

#### **General specifications**

Reflow: MIL-STD-202G Condition J, +245 °C  $\pm$  5 °C, 30 s  $\pm$  5 s, 1 times reflow

Solderability: J-STD-002. 8 hours steam age test, Flux type: ROLO, Solder: +245 °C ± 5 °C

Mechanical shock: MIL-STD-202 Method 213. Half-sine shock pulse, peak=100 g/s, 6.0 ms, total 18 shocks

Vibration: MIL-STD-202, Method 204. Gravity= 10 g, Frequency= 10 Hz to 55 Hz to 10 Hz, Direction: 3 ( X,Y, Z), each 12 cycles, Duration= 20 minutes in each direction

Salt spray: GB/T6461-2002, Salt spray concentration=  $5\% \pm 1\%$ , Test temperature=  $+35 \pm 2$  °C, pH value= 6.5 to 7.2, Time= 48 hours, After removing the product, wash in warm water or salted water, then natural air-dried for 1 hour

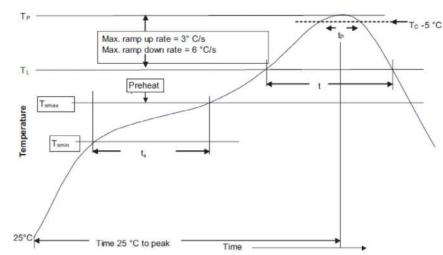
High temperature storage test: MIL-STD-202G Method 108, +125 °C, Duration= 1000 hours

Temperature cycling: JESD22 Method JA-104, High temperature = +125 °C, low temperature -40 °C, conversion time 30 minutes, 100 cycles.

Biased humidity: MIL-STD-202G Method 103, +85 °C, 85% RH, Duration= 1000 hours.

Life: MIL-STD-202 Method 108, 1000 hours, +85 °C at rated  $I_{ms}$  (Ambient plus self temperature rise no more than +125 °C)

#### Solder reflow profile



T<sub>C</sub> -5 °C Table 1 - Standard SnPb solder (T<sub>C</sub>)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T<sub>C</sub>)

Package thickness	Volume mm³ <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T <sub>smin</sub> )	100 °C	150 °C
Temperature max. (T <sub>smax</sub> )	150 °C	200 °C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Ramp up rate $T_L$ to $T_p$	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time (t <sub>L</sub> ) maintained above $T_L$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature $(T_c)$	10 seconds*	10 seconds*
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

 $<sup>^{\</sup>star}$  Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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